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PATENT ASSIGNMENT COVER SHEET

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NATURE OF CONVEYANCE:		ASSIGNMENT	ASSIGNMENT		
CONVEYING PARTY D	ΑΤΑ				
		Name		Execution Date	
HIROHISA MATSUKI				05/29/2015	
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State/Country:	JAPAN	JAPAN			
Postal Code:	222-003	222-0033			
PROPERTY NUMBERS	Total: 1				
Property Type		Number			
Application Number:	1	14587521			
	e sent to provided; 2	202)822-1111 <i>the e-mail address first; if that</i> ; <i>if that is unsuccessful, it will k</i> 2028221100 patentmail@whda.com			
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Verification of Translation

I, <u>Ken-Ichi Hattori</u>, do hereby declare that I am knowledgeable in the English language and in Japanese language, and that I believe the English language in the foregoing Declaration is a full and faithful translation of the Japanese language of the document. I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Signature of verifier: Name of verifier: Post office address of verifier:

Date of signature:

()

Mr. Ken-Ichi Hattori 1250 Connecticut Ave N.W. Suite 700 Washington DC 20036 USA January 2, 2014

Assignment With Declaration for Utility or Design Patent Application (37 C.F.R. 1.63) 特許またはデザイン特許出願用宣言書付き譲渡書

Japanese Language Assignment with Declaration

日本語宣言書付き譲渡書

DECLARATION

宜言書

私は、以下に記名された発明者として、ここに下記の通り宣言 As a below named inventor, I hereby declare that: する:

私は、下記の名称の出願について、特許請求範囲に記載されて 1 believe 1 am the original inventor or an original joint inventor of a claimed invention in the below-entitled application: いる発明の真の発明者であるか、或いは真の共同発明者である と信じている:

発明の名称を記入:

Insert Title:

SEMICONDUCTOR DEVICE AND METHOD FOR MANUFACTURING THE SAME

下記の欄がチェックされている場合を除き、ここに添付されて the application of which is attached hereto unless the いる上記出願は、

following is checked:

□_____日に米国出願番号_____ として出願され、且つ/または____日に

PCT国際出願番号 として出願された。

was filed on 12/31/2014 as United States Application

Number 14/587521 and/or was filed on

as PCT International Application

Number _____.

上記出願は、私が作成したものか、あるいは私がその作成を 認めたものである。

私は、この宣言書において故意に偽りを述べた場合、合衆国法 典第18巻第1001条に基づき、罰金あるいは5年以下の懲役、 または両方の懲罰が課され得ることを認識している。

The above-identified application was made or authorized to be made by me.

I hereby acknowledge that any willful false statement made in this Declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both,

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PATENT REEL: 035815 FRAME: 0440

ASSIGNMENT 譲渡書

下記の者(以下、議受人)によって提供され、そしてその適切 FOR GOOD AND VALUABLE CONSIDERATION, the adequacy and 性と受領は下記に署名した発明者(達) (以下、譲渡人)に receipt of which are hereby acknowledged by the よって承認された、適正で価値のある対価をもって、

undersigned inventor(s) (hereinafter ASSIGNOR), from

譲受人名/住所:

Insert Assignce(s)Name/Address:

Socionext Inc. 2-10-23 Shin-Yokohana, Kohoku-ku, Yokohana-shi, Kanagawa 222-0033 Japan

下記に署名をした譲渡人は、ここに、上記出願(その基礎と なり得るいかなる仮出願を含む)およびその全期間又は許可 された期間に渡る、上記出顧或いはその継続、分割、代替再発行、再審査、補足審査、当事者系レヴュー、登録後レヴュー、 またはその他の手続によって得られる全ての米国特許の、全て の且つ排他的な権利、権限、利権、もしあるなら過去侵害の 訴権を含む、および合衆国法典第35巻第154条に従う全ての 権利、を譲受人に売却・譲渡・移転する。

(hereinafter ASSIGNEE), the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to, including the right to sue for past infringement, if any, and all rights pursuant to 35 U.S.C. 154, the above-identified application (including any provisional application upon which it may be based), and all Letters Patent of the United States to be obtained therefore on said application or any continuation, divisional, substitute, reissue, reexamination, supplemental examination, inter partes review, post grant review, or other procedures thereof for the full term or terms for which the same may be granted.

The ASSIGNOR agrees to execute all papers necessary in

connection with the application and/or Letters Patent

and any continuation, divisional, substitute, reissue, reexamination, supplemental examination, inter partes

review, post grant review, or other procedures thereof

and also to execute separate assignments in connection with such applications and/or Letters Patent as the

ASSIGNEE may deem necessary or expedient.

譲渡人は、上記出顧及び/または特許証、およびその継続、 分割、代替、再発行、再審査、補足審査、当事者系レヴュー 登録後レヴュー、またはその他の手続に係わる全ての必要書類 を完成する事に、および譲受人が必要または便宜的であると考 えるような、出願及び/または特許証に係わる別の譲渡書を完 成する事にも同意する。

譲渡人は、この出顧及び/または特許証、およびその継続、 分割、代替、再発行、再審査、補足審査、当事者系レヴュー、 登録後レヴュー、その他の手続に関する、インターフェアラン ス、訴訟、あるいは他の法的な処置に任わる全ての必要な書類 を完成する事に、および証拠の取得や生成およびそのインター フェアレンス、訴訟、あるいはその他の法的処置における手続 において、可能なあらゆる方法で譲受人に協力する事に同意す δ.

ここに、下記の署名者により、その署名者名の署名の横に記載 された日に署名された:

The ASSIGNOR agrees to execute all papers necessary in connection with any interference, litigation, or other legal proceeding concerning this application and/or Letters Patent and any continuation, divisional, substitute, reissue, reexamination, supplemental examination, inter partes review, post grant review, or other procedures thereof and to cooperate with the ASSIGNEE in every way possible in obtaining and producing evidence and proceeding with such interference, litigation, or other legal proceeding,

Hereby executed by the undersigned on the date opposite the signature of the undersigned's name:

発明者の正式な氏名

発明者の署名

日付

Signature

Legal Name of Inventor: Hirohisa Matsuki

Date

may 29.2015

注:本書面に必要な情報やサインは英語右欄のみに記入。日本語左欄は英語原本理解のための参考情報

PATENT REEL: 035815 FRAME: 0441

RECORDED: 06/10/2015

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